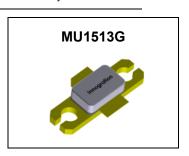
# 40W, 12.5V High Power RF LDMOS FETs

## **Description**

The MU1513G is a 40-watt P1dB (50W P3dB) high performance, unmatched LDMOS FET, designed for wide-band commercial and industrial applications with frequencies HF to 0.5 GHz.



•Typical 520MHz Performance (On Innogration fixture with device soldered):

V <sub>ds</sub> = 12.5V, V <sub>gs</sub> =2.49V,I <sub>dq</sub> =120mA					
Test signal	P-1(dBm)	P-1Gain(dB)	P-3(dBm)	P-3(W)	EFF (%)
CW	46.17	24.9	47.21	52.6	70.4

### **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### **Suitable Applications**

- 2-30MHz (HF or Short wave communication)
- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)

### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	$V_{\scriptscriptstyle DSS}$	+65	Vdc
GateSource Voltage	$V_{\sf GS}$	-10 to +10	Vdc
Operating Voltage	$V_{DD}$	+28	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	T,	+225	°C

### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Dolo	0.50	00/14/
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C, DC test	RөJC	0.58	°C/W

#### **Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

### Table 4. Electrical Characteristics (T<sub>A</sub> = 25 °C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
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#### **DC Characteristics**

Drain-Source Voltage	$V_{(BR)DSS}$	65	70		V
V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA					
Zero Gate Voltage Drain Leakage Current	I <sub>DSS</sub>			1	μА
$(V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V})$	IDSS			'	μΑ
GateSource Leakage Current				1	^
$(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$	I <sub>GSS</sub>			I	μА
Gate Threshold Voltage	V (u)		1.98		V
$(V_{DS} = 28V, I_D = 600 \mu A)$	$V_{GS}(th)$		1.90		V
Gate Quiescent Voltage	W		2.5		V
(V <sub>DD</sub> = 28 V, I <sub>D</sub> = 100 mA, Measured in Functional Test)	$V_{GS(Q)}$	<u>——</u>	2.5	<u>——</u>	V
Drain source on state resistance	D.1-()		440		0
$(V_{DS} = 0.1V, V_{GS} = 10 V)$	Rds(on)		110		mΩ
Common Source Input Capacitance			116		5 F
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	C <sub>iss</sub>		110		pF
Common Source Output Capacitance	0		50		F
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	Coss		50		pF
Common Source Feedback Capacitance					~F
(V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	$C_{RSS}$		2		pF

Functional Tests (In Demo Test Fixture, 50 ohm system) V<sub>DD</sub> = 12.5 Vdc, I<sub>DQ</sub> = 100 mA, f = 500 MHz, Pused CW Signal Measurements.

Power Gain	Gp	 24	 dB
Drain Efficiency@P1dB	η₀	 65	 %
1 dB Compression Point	P <sub>-1dB</sub>	40	W

Load Mismatch (In Innogration Test Fixture, 50 ohm system):  $V_{DD} = 12.5 \text{ Vdc}$ ,  $I_{DQ} = 100 \text{ mA}$ , f = 500 MHz

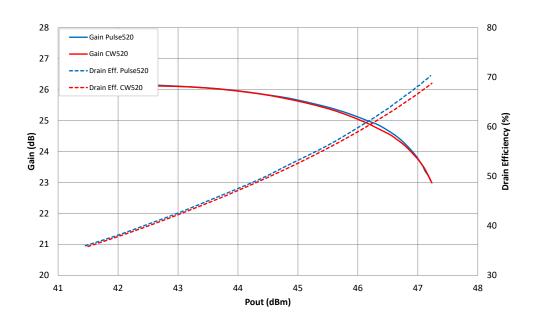
VSWR 10:1 at 40W Pulsed CW Output Power No Device Degradation

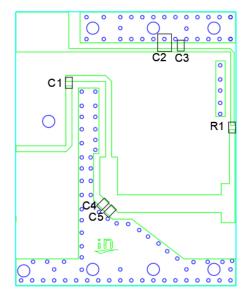
Figure 1: Network analyzer Output S11/S21

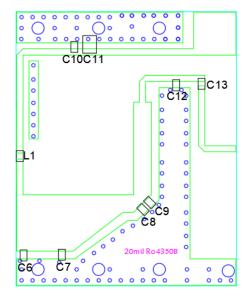


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Figure 2: Power gain, efficiency as function of Pout







Component	Value	Description
C1,C3,C10,C13	220pF	MQ300805C
C2,C11	10uF	TDK1206
C4,C7	22pF	ATC600S
C5	5.1pF	ATC600S
C6	10pF	ATC600S
C8	20pF	ATC600S
C9	15pF	ATC600S
C12	1.8pF	ATC600S
R1	10 Ω	1
L1	32nH	

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## **Package Outline**

### Flanged ceramic package; 2 leads

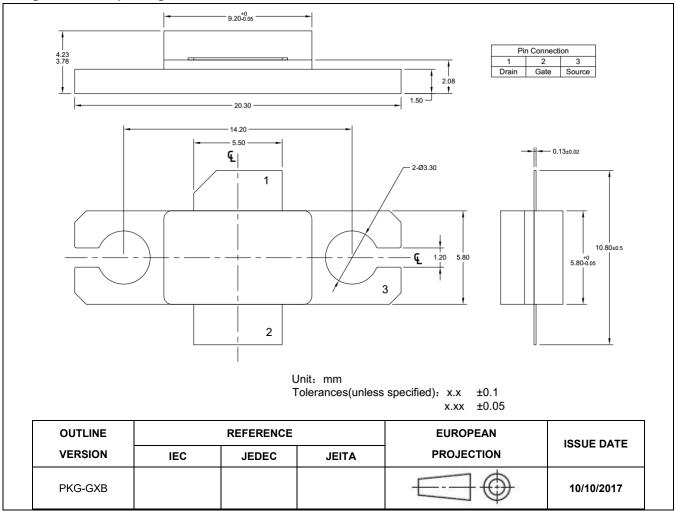


Figure 1. Package Outline PKG-G2E

### **Revision history**

Table 5. Document revision history

Date	Revision	Datasheet Status
2024/6/5	Rev 1.0	Preliminary Datasheet Creation
2025/6/13	Rev 1.1	Update the performance summary on 1st page after recalibration

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